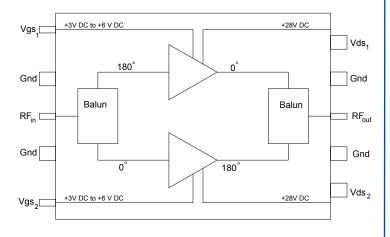
# **Product Description**

Sirenza Microdevices' SDM-09060-B1F 65W power module is a robust impedance matched, single-stage, push-pull Class AB amplifier module suitable for use as a power amplifier driver or output stage. The power transistors are fabricated using Sirenza's latest, high performance LDMOS process. It is a drop-in, no-tune solution for high power applications requiring high efficiency, excellent linearity, and unit-tounit repeatability. It is internally matched to 50 ohms.

## **Functional Block Diagram**

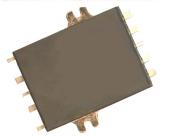


#### Case Flange = Ground

## SDM-09060-B1F SDM-09060-B1FY



925-960 MHz Class AB 65W Power Amplifier Module



### **Product Features**

- Available in RoHS compliant packaging
- 50  $\Omega$  RF impedance
- 65W Output P<sub>1dB</sub>
- Single Supply Operation : Nominally 28V
- High Gain: 17 dB at 942 MHz
- High Efficiency : 44% at 942 MHz
- ESD Protection: JEDEC Class 2 (2000V HBM)

## **Applications**

- **Base Station PA driver**
- Repeater
- **CDMA** •
- **GSM / EDGE**

Parameter	Units	Min.	Тур.	Max.
Frequency of Operation	MHz	925	-	960
Output Power at 1dB Compression, 943 MHz	W	60	65	-
Gain at 60W PEP, 942MHz and 943MHz	dB	16	17	-
Peak-to-Peak Gain Variation, 60W PEP, 925 - 960MHz	dB	-	0.3	0.5
Drain Efficiency at 60W PEP, 942MHz and 943MHz	%	32	34	-
Drain Efficiency at 60W CW, 942MHz	%		44	-
Input Return Loss 60W PEP Output Power, 925 - 960MHz	dB	-	-15	-12
3rd Order IMD Product, 60W PEP, 942MHz and 943MHz	dBc	-	-31	-27
Signal Delay from Pin 3 to Pin 8	nS	-	4.0	-
Deviation from Linear Phase (Peak-to-Peak)	Deg	-	0.5	-
Thermal Resistance (Junction to Case)	°C/W		1.5	
	Frequency of OperationOutput Power at 1dB Compression, 943 MHzGain at 60W PEP, 942MHz and 943MHzPeak-to-Peak Gain Variation, 60W PEP, 925 - 960MHzDrain Efficiency at 60W PEP, 942MHz and 943MHzDrain Efficiency at 60W CW, 942MHzInput Return Loss 60W PEP Output Power, 925 - 960MHz3rd Order IMD Product, 60W PEP, 942MHz and 943MHzSignal Delay from Pin 3 to Pin 8Deviation from Linear Phase (Peak-to-Peak)	Frequency of OperationMHzOutput Power at 1dB Compression, 943 MHzWGain at 60W PEP, 942MHz and 943MHzdBPeak-to-Peak Gain Variation, 60W PEP, 925 - 960MHzdBDrain Efficiency at 60W PEP, 942MHz and 943MHz%Drain Efficiency at 60W CW, 942MHz%Input Return Loss 60W PEP Output Power, 925 - 960MHzdB3rd Order IMD Product, 60W PEP, 942MHz and 943MHzdBcSignal Delay from Pin 3 to Pin 8nSDeviation from Linear Phase (Peak-to-Peak)Deg	Frequency of OperationMHz925Output Power at 1dB Compression, 943 MHzW60Gain at 60W PEP, 942MHz and 943MHzdB16Peak-to-Peak Gain Variation, 60W PEP, 925 - 960MHzdB-Drain Efficiency at 60W PEP, 942MHz and 943MHz%32Drain Efficiency at 60W CW, 942MHz%32Input Return Loss 60W PEP Output Power, 925 - 960MHzdB-3rd Order IMD Product, 60W PEP, 942MHz and 943MHzdB-Signal Delay from Pin 3 to Pin 8nS-Deviation from Linear Phase (Peak-to-Peak)Deg-	Frequency of OperationMHz925-Output Power at 1dB Compression, 943 MHzW6065Gain at 60W PEP, 942MHz and 943MHzdB1617Peak-to-Peak Gain Variation, 60W PEP, 925 - 960MHzdB-0.3Drain Efficiency at 60W PEP, 942MHz and 943MHz%3234Drain Efficiency at 60W CW, 942MHz%44Input Return Loss 60W PEP Output Power, 925 - 960MHzdB153rd Order IMD Product, 60W PEP, 942MHz and 943MHzdB31Signal Delay from Pin 3 to Pin 8nS-4.0Deviation from Linear Phase (Peak-to-Peak)Deg-0.5

## **Quality Specifications**

Parameter	Description	Unit	Typical
ESD Rating	Human Body Model	Volts	2000
MTTF	200°C Channel	Hours	1.2 X 10 <sup>6</sup>

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EDS-104211Rev D

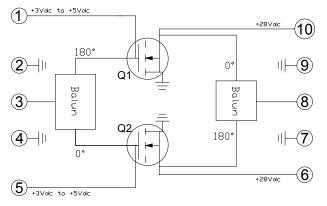
## **Key Specifications**



#### **Pin Description**

Pin #	Function	Description
1	V <sub>GS1</sub>	LDMOS FET Q1 gate bias. V <sub>GSTH</sub> 3.0 to 5.0 VDC. See Notes 2, 3 and 4
2,4,7,9	Ground	Module Topside ground.
3	RF Input	Module RF input. This pin is internally connected to DC ground. Do not apply DC voltages to the RF leads. Care must be taken to protect against video transients that may damage the active devices.
5	V <sub>GS2</sub>	LDMOS FET Q2 gate bias. V <sub>GSTH</sub> 3.0 to 5.0 VDC. See Notes 2, 3 and 4
6	V <sub>D2</sub>	LDMOS FET Q2 drain bias. See Note 1.
8	RF Output	Module RF output. This pin is internally connected to DC ground. Do not apply DC voltages to the RF leads. Care must be taken to protect against video transients that may damage the active devices.
10	V <sub>D1</sub>	LDMOS FET Q1 drain bias. See Note 1.
Flange	Ground	Baseplate provides electrical ground and a thermal transfer path for the device. Proper mounting assures optimal performance and the highest reliability. See Sirenza applications note AN-054 Detailed Installation Instructions for Power Modules.

#### **Simplified Device Schematic**



Case Flange = Ground

### **Absolute Maximum Ratings**

Parameters	Value	Unit
Drain Voltage (V <sub>DD</sub> )	35	V
RF Input Power	+37	dBm
Load Impedance for Continuous Operation Without Damage	5:1	VSWR
Control (Gate) Voltage, VDD = 0 VDC	15	V
Output Device Channel Temperature	+200	°C
Operating Temperature Range	-20 to +90	°C
Storage Temperature Range	-40 to +100	°C

Operation of this device beyond any one of these limits may cause permanent damage. For reliable continuous operation see typical setup values specified in the table on page one.

#### Note 1:

Internal RF decoupling is included on all bias leads. No additional bypass elements are required, however some applications may require energy storage on the V<sub>D</sub> leads to accommodate modulated signals.

#### Note 2:

Gate voltage must be applied to  $V_{GS}$  leads simultaneously with or after application of drain voltage to prevent potentially destructive oscillations. Bias voltages should never be applied to a module unless it is properly terminated on both input and output.

#### Note 3:

The required V<sub>GS</sub> corresponding to a specific I<sub>DQ</sub> will vary from module to module and may differ between V<sub>GS1</sub> and V<sub>GS2</sub> on the same module by as much as ±0.10 volts due to the normal die-to-die variation in threshold voltage for LDMOS transistors.

#### Note 4:

The threshold voltage ( $V_{GSTH}$ ) of LDMOS transistors varies with device temperature. External temperature compensation may be required. See Sirenza application notes AN-067 LDMOS Bias Temperature Compensation.

#### Note 5:

This module was designed to have it's leads hand soldered to an adjacent PCB. The maximum soldering iron tip temperature should not exceed 700° C, and the soldering iron tip should not be in direct contact with the lead for longer than 10 seconds. Refer to app note AN054 (www.sirenza.com) for further installation instructions.

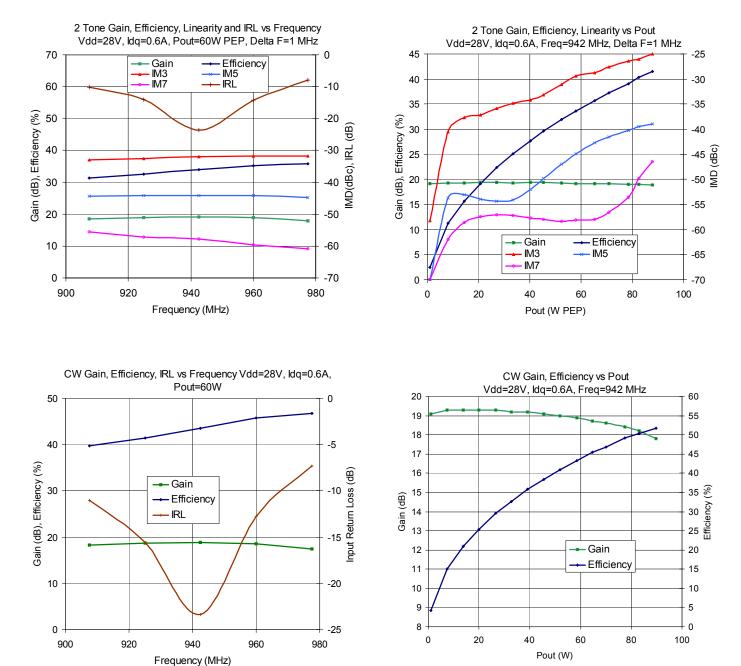


**Caution: ESD Sensitive** Appropriate precaution in handling, packaging and testing devices must be observed.

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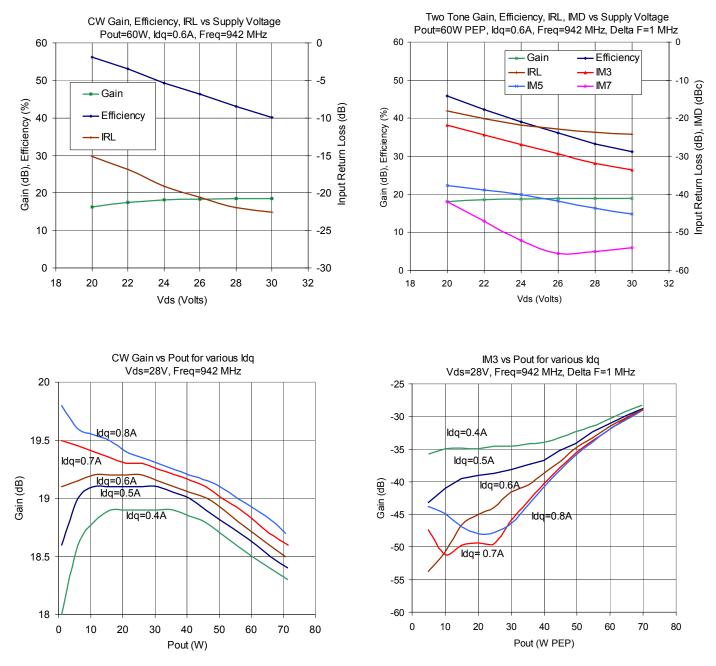


## **Typical Performance Curves**









#### Note:

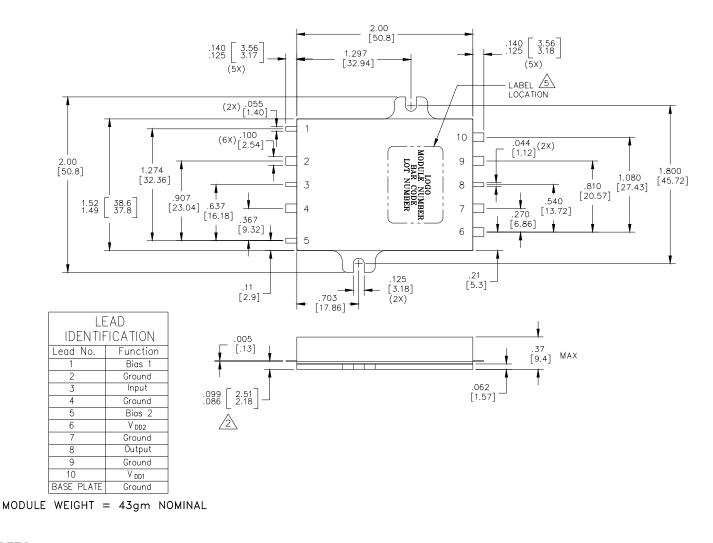
Evaluation test fixture information available on Sirenza Website, referred to as SDM-EVAL.

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## Package Outline Drawing



NOTES: UNLESS OTHERWISE SPECIFIED

1. INTERPRET DRAWING PER ANSI Y14.5..

A MEASURE FROM THE BOTTOM OF THE LEADS.

3. DIMENSIONS ARE INCHES[MM].

4. LEAD IDENTIFICATION IS FOR REFERENCE ONLY.

5 ORIENTATION OF LABEL IS TO BE AS SHOWN.

#### Note:

Refer to Application note AN054, "Detailed Installation Instructions for Power Modules" for detailed mounting information.

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